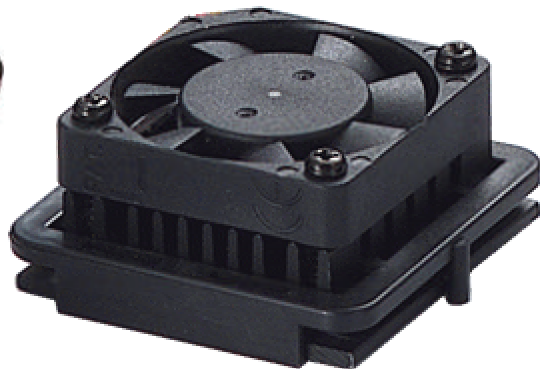




Model : CEBF0135351602-00

BGA Cooler

For 35 x 35mm Chip Set



SPECIFICATION

COOLER

Total dimension	35*35*16(h)mm
Weight	18g
Rth	2.32 °C/W

HEATSINK

Material	Al 6063
Technology	Extrusion
Dimension	35*35*10(h)mm
Base (thickness)	1.7mm
Weight	15g.
Finish	Black Anodize

FAN

Dimension	30*30*6(h)mm.
Bearing	Vapo
Voltage	5V.DC
Current	0.13Amp
Speed	9500 R.P.M.
Air flow	4.9 CFM
Noise	28 dB-A

ACCESSORY :

Clip	Plastic(UL94-V0)
Thermal Tap	Chomerics T710